# Low Output Voltage, Ultra-Fast 1.0 A Low Dropout Linear Regulator with Enable

The NCP5661/NCV5661 is a high performance, low dropout linear regulator designed for high power applications that require up to 1.0 A current. It is offered in both fixed and adjustable output versions. With output voltages as low as 0.9 V and ultra-fast response times for load transients, the NCP5661/NCV5661 also provides additional features such as Enable and Error Flag (for the fixed output version), increasing the utility of these devices. A thermally robust, 5 pin DPAK or DFN 3x3.3 mm, combined with an architecture that offers low ground current (independent of load), provides for a superior high-current LDO solution.

#### **Features**

- Ultra-Fast Transient Response (Settling Time: 1–3 μs)
- Low Noise Without Bypass Capacitor (26 μV<sub>rms)</sub>
- Low Ground Current Independent of Load (3.0 mA Maximum)
- Fixed/Adjustable Output Voltage Versions
- Enable Function
- Error Flag (Fixed Output Version)
- Current Limit Protection
- Thermal Protection
- 0.9 V Reference Voltage for Ultra-Low Output Operation
- Power Supply Rejection Ratio > 65 dB
- NCV Prefix for Automotive and Other Applications Requiring AECQ-100 Qualified Site and Change Controls
- These are Pb-Free Devices

#### **Applications**

- Servers
- ASIC Power Supplies
- Post Regulation for Power Supplies
- Constant Current Source
- Networking Equipment
- Gaming and STB Modules



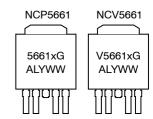
#### ON Semiconductor®

http://onsemi.com

#### MARKING DIAGRAMS



DPAK-5 CENTER LEAD CROP CASE 175AA





CASE 506AX

1 661x AYWW• NCV5661 1 V661 zzz AYWW•

x = A for Adjustable Version

B for Fixed 1.2 V

C for Fixed 3.3 V

D for Fixed 1.5 V E for Fixed 1.8 V

F for Fixed 2.5 V

G for Fixed 2.8 V

H for Fixed 3.0 V

zzz = 12 for Fixed 1.2 V

15 for Fixed 1.5 V

18 for Fixed 1.8 V

25 for Fixed 2.5 V

20 101 FIXEU 2.5 V

28 for Fixed 2.8 V

30 for Fixed 3.0 V

33 for Fixed 3.3 V

ADJ for Adjustable Version

A = Assembly Location

L = Wafer Lot

Y = Year

WW = Work Week

G = Pb-Free

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

#### PIN FUNCTION DESCRIPTION

Pin Adj/Fixed DFN6	Pin Adj/Fixed DPAK-5	Pin Name	Description
D1 110	DI AIL 0	i ili italile	Description
1	1	Enable	This pin allows for on/off control of the regulator. To disable the device, connect to Ground. If this function is not in use, connect to $V_{\rm in}$ .
2,3	2	V <sub>in</sub>	Positive Power Supply Input Voltage
4, EPAD	3, TAB	Ground	Power Supply Ground
5	4	V <sub>out</sub>	Regulated Output Voltage
6	5	Adj (Adjustable Version)	This pin is connected to the resistor divider network and programs the output voltage.
6	5	Error Flag (Fixed Version)	An Error Flag is triggered when the output voltage is out of regulation excluding transient signals that may occur. Requires a pullup resistor $\approx$ 100 k $\Omega$ .

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input Voltage	V <sub>in</sub>	18	V
Output Pin Voltage	V <sub>out</sub>	-0.3 to Vin +0.3	V
Adjust Pin Voltage	$V_{adj}$	-0.3 to Vin +0.3	V
Enable Pin Voltage	V <sub>en</sub>	-0.3 to Vin +0.3	V
Error Flag Voltage	V <sub>ef</sub>	-0.3 to Vin +0.3	V
Error Flag Current	l <sub>ef</sub>	3.0	mA
Thermal Characteristics, DPAK-5 (Note 1) Thermal Resistance, Junction-to-Air Thermal Resistance, Junction-to-Case	R <sub>θJA</sub> R <sub>θ</sub> JC	100 8.0	°C/W
Thermal Characteristics, DFN6 (Note 2) Thermal Resistance, Junction-to-Air Thermal Resistance, Junction-to-Lead (Note 3)	R <sub>eJA</sub> R <sub>eJL</sub>	82 18	°C/W
Operating Junction Temperature Range	TJ	-40 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect

NOTE: This device series contains ESD protection and exceeds the following tests:

Human Body Model (HBM) JESD 22-A114-B

Machine Model (MM) JESD 22-A115-A.

The maximum package power dissipation is:

$$P_D = \frac{T_{J(max)} - T_{A}}{R_{\theta JA}}$$

The bipolar process employed for this IC is fully characterized and rated for reliable 18 V V<sub>CCmax</sub> operation. To avoid damaging the part or degrading it's reliability, power dissipation transients should be limited to under 20 W for DPAK.

For open-circuit to short-circuit transient,

- P<sub>DTransient</sub> = V<sub>CCmax</sub> \* I<sub>SC</sub>.

  1. 1 oz copper, 0.26 in<sup>2</sup> copper area (minimum pad)
- 2. 1 oz copper, 1 in<sup>2</sup> copper area
- 3. Lead 2

### **ELECTRICAL CHARACTERISTICS**

 $(V_{in}-V_{out}=1.5~V,~for~typical~values~T_{J}=25^{\circ}C,~for~min/max~values~T_{J}=-40^{\circ}C~to~125^{\circ}C,~C_{in}=C_{out}=150~\mu F~unless~otherwise~noted.)$ 

5					,
Characteristic	Symbol	Min	Тур	Max	Unit
ADJUSTABLE OUTPUT VERSION					
Input Voltage	V <sub>in</sub>	2.0	_	9.0	V
Output Noise Voltage (f = 10 Hz to 100 kHz)	V <sub>n</sub>	-	26	-	$\mu V_{rms}$
Output Voltage Accuracy $T_J = 25^{\circ}C \ (I_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -20 \text{ to } +125^{\circ}C \ (I_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -40 \text{ to } +150^{\circ}C \ (I_{out} = 10 \text{ mA to } 1.0 \text{ A})$		-1% -1.5% -2%	- 0.9 -	+1% +1.5% +2%	V
Adjustable Pin Input Current	I <sub>adj</sub>	-	40	-	nA
Line Regulation ( $I_{out}$ = 10 mA, $V_{out}$ +1.5 V < $V_{in}$ < 7.0 V)	REG <sub>line</sub>	-	0.03	-	%
Load Regulation (10 mA < I <sub>out</sub> < 1.0 A)	REG <sub>load</sub>	-	0.03	-	%
Dropout Voltage (I <sub>out</sub> = 1.0 A)	$V_{DO}$	-	1.0	1.3	V
Peak Output Current Limit	l <sub>out</sub>	1.0	-	-	Α
Internal Current Limitation	I <sub>lim</sub>	-	1.5	-	Α
Ripple Rejection (120 Hz) Ripple Rejection (1.0 kHz)	RR	- -	70 65	- -	dB
Thermal Shutdown (Guaranteed by Design)		-	160	-	°C
Ground Current  I <sub>out</sub> = 1.0 A Disabled State	I <sub>q</sub> I <sub>qds</sub>	- -	1.3 10	3.0 300	mA μA
Enable Input Threshold Voltage  Voltage Increasing, On State, Logic High  Voltage Decreasing, Off State, Logic Low	V <sub>en</sub>	1.3 -	- -	- 0.3	V
Enable Input Current $ {\rm Enable\ Pin\ Voltage = 0.3\ V_{max} }  $ $ {\rm Enable\ Pin\ Voltage = 1.3\ V_{min} } $	I <sub>en</sub>	- -	0.5 0.5	- -	μΑ

### **ELECTRICAL CHARACTERISTICS**

 $(V_{in}-V_{out}=1.5~V,~for~typical~values~T_{J}=25^{\circ}C,~for~min/max~values~T_{J}=-40^{\circ}C~to~125^{\circ}C,~C_{in}=C_{out}=150~\mu F~unless~otherwise~noted.)$ 

Characteristic	Symbol	Min	Тур	Max	Unit
FIXED OUTPUT VOLTAGE					
Input Voltage	V <sub>in</sub>	2.0	-	9.0	V
Output Noise Voltage (V <sub>out</sub> = 0.9 V)	V <sub>n</sub>	-	26	-	$\mu V_{rms}$
Output Voltage Accuracy $T_J = 25^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -20 \text{ to } +125^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$ $T_J = -40 \text{ to } +150^{\circ}\text{C (I}_{out} = 10 \text{ mA to } 1.0 \text{ A})$	V <sub>out</sub>	-1% -1.5% -2%	- V <sub>out</sub> -	+1% +1.5% +2%	V
Line Regulation ( $I_{out}$ = 10 mA, $V_{out}$ +1.5 V < $V_{in}$ < 7.0 V)	REG <sub>line</sub>	_	0.03	-	%
Load Regulation (10 mA < I <sub>out</sub> < 1.0 A)	REG <sub>load</sub>	-	0.2	-	%
Dropout Voltage (I <sub>out</sub> = 1.0 A)	$V_{DO}$	-	1.0	1.3	V
Peak Output Current Limit	I <sub>out</sub>	1.0	-	-	Α
Internal Current Limitation	I <sub>lim</sub>	-	1.5	-	Α
Ripple Rejection (120 Hz) Ripple Rejection (1.0 kHz)	RR	- -	70 65	- -	dB
Thermal Shutdown (Guaranteed by Design)	T <sub>SHD</sub>	-	160	-	°C
Ground Current  I <sub>out</sub> = 1.0 A Disabled State	I <sub>q</sub> I <sub>qds</sub>	- -	1.3 30	3.0 300	mA μA
Enable Input Threshold Voltage  Voltage Increasing, On State, Logic High  Voltage Decreasing, Off State, Logic Low	V <sub>en</sub>	1.3 -	- -	- 0.3	V
Enable Input Current	l <sub>en</sub>	- -	0.5 0.5	- -	μΑ
Error Flag (Fixed Output)  1.2 V Output 1.5 V Output 1.8 V Output 2.5 V Output 2.8 V Output 3.0 V Output 3.3 V Output	V <sub>eflt</sub>	88 88 88 88 88 88 90	92 92 92 92 92 92 92 94	97 97 97 97 97 97 97	% of V <sub>out</sub>
Error Flag Output Low Voltage Saturation (I <sub>ef</sub> = 1.0 mA)	V <sub>efdo</sub>	-	200	-	mV
Error Flag Leakage	l <sub>efleak</sub>	-	1.0	-	μΑ
Error Flag Blanking Time (Note 4)	T <sub>ef</sub>	_	50	-	μs

<sup>4.</sup> Error Flag Blanking Time

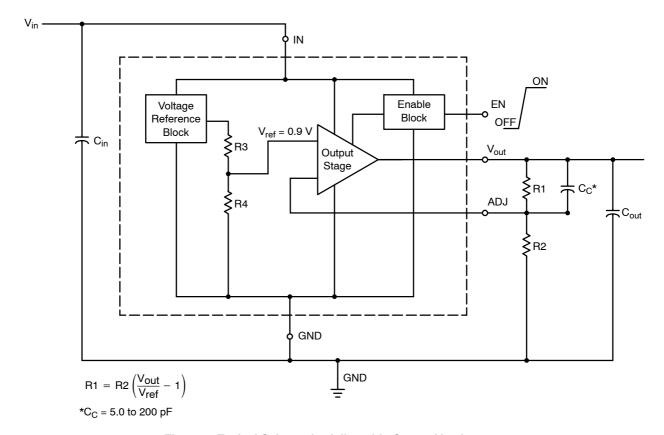


Figure 1. Typical Schematic, Adjustable Output Version

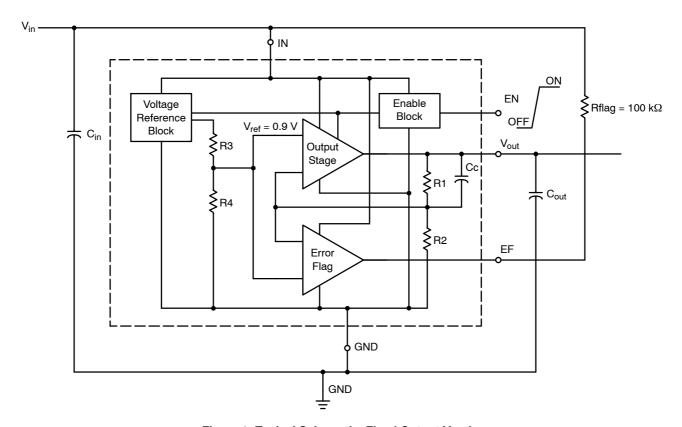
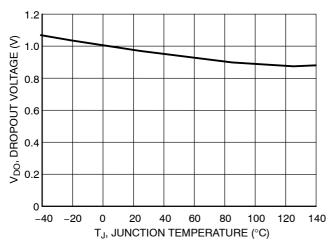


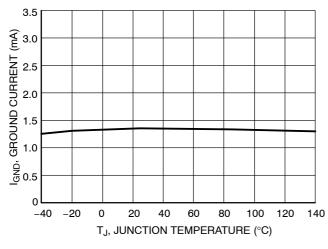
Figure 2. Typical Schematic, Fixed Output Version



1.00 V<sub>DO</sub>, DROPOUT VOLTAGE (V) 0.95 0.90 0.85 0.80 V<sub>out</sub> = 2.5 V Adjustable  $C_{in}$  = 150  $\mu$ F  $C_{out}$  = 10 to 150  $\mu$ F 0.75 T<sub>J</sub> = 25°C 0.70 0.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 8.0 0.9 I<sub>out</sub>, OUTPUT CURRENT (A)

Figure 3. Dropout Voltage vs. Temperature

Figure 4. Dropout Voltage vs. Output Current



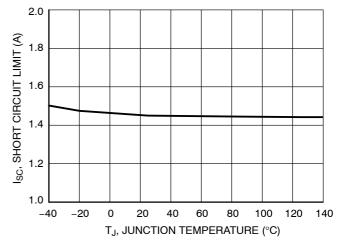
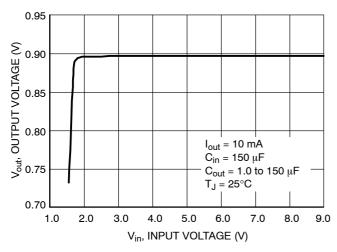


Figure 5. Ground Current vs. Temperature

Figure 6. Short Circuit Current Limit vs. Temperature



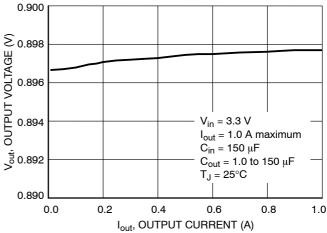


Figure 7. Output Voltage vs. Input Voltage

Figure 8. Output Voltage vs. Output Load Current

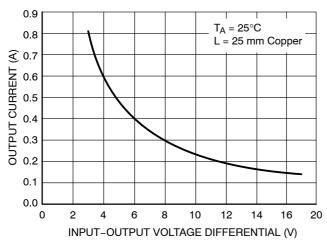


Figure 9. Output Current vs. Input-Output Voltage Differential

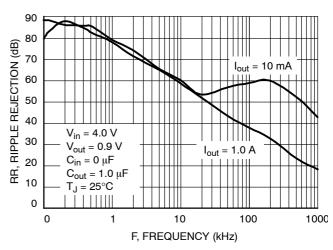


Figure 10. Ripple Rejection vs. Frequency

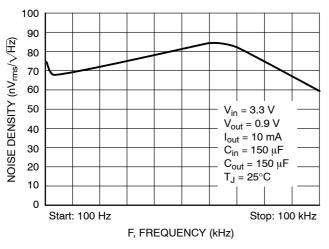


Figure 11. Noise Density vs. Frequency

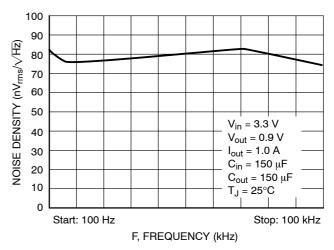


Figure 12. Noise Density vs. Frequency

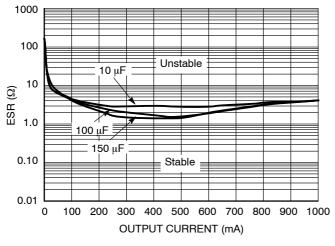


Figure 13. 1.2 Volt Output Stability with Output Capacitor ESR

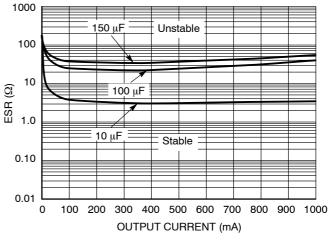


Figure 14. 3.3 Volt Output Stability with Output Capacitor ESR

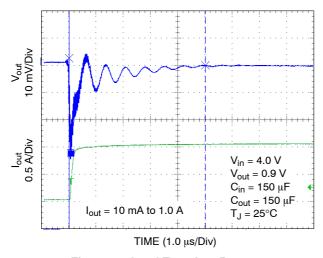


Figure 15. Load Transient Response

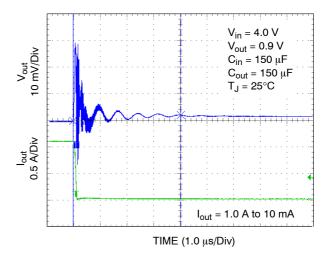


Figure 16. Load Transient Response

#### **APPLICATION INFORMATION**

The NCP5661 is a high performance low dropout 1.0 A linear regulator suitable for high power applications, featuring an ultra–fast response time and low noise without a bypass capacitor. It is offered in both fixed and adjustable output versions with voltages as low as 0.9 V. Additional features, such as Enable and Error Flag (fixed output version) increase the utility of the NCP5661. It is thermally robust and includes the safety features necessary during a fault condition, which provide for an attractive high current LDO solution for server, ASIC power supplies, networking equipment applications, and many others.

#### **Input Capacitor**

The recommended input capacitor value is a 150  $\mu F$  OSCON with an Equivalent Series Resistance (ESR) of 50 m $\Omega$ . It is especially required if the power source is located more than a few inches from the NCP5661. This capacitor will reduce device sensitivity and enhance the output transient response time. The PCB layout is very important and in order to obtain the optimal solution, the Vin and GND traces should be sufficiently wide to minimize noise and unstable operation.

### **Output Capacitor**

Proper output capacitor selection is required to maintain stability. The NCP5661 is guaranteed to be stable at an output capacitance of,  $C_{out} > 10~\mu F$  with an ESR between  $50~m\Omega$  and  $300~m\Omega$  over the output current range of 10~mA to 1.0~A. For PCB layout considerations, place the recommended ceramic capacitor close to the output pin and keep the leads short. This should help ensure ultra–fast transient response times.

#### **Adjustable Output Operation**

The application circuit for the adjustable output version is shown in Figure 1. The reference voltage is 0.9 V and the

adjustable pin current is typically 40 nA. A resistor divider network, R1 and R2, is calculated using the following formula:

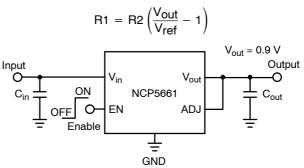


Figure 17. To achieve the minimum output voltage, ADJ to  $V_{out}$  has to be connected together

#### **Current Limit Operation**

As the peak output current increases beyond its limitation, the device is internally clampled to 1.5 A, thus causing the output voltage to decrease and go out of regulation. This allows the device never to exceed the maximum power dissipation.

#### **Error Flag Operation**

The Error Flag pin on the NCP5661 will produce a logic Low when it drops below the nominal output voltage. Refer to the electrical characteristics for the threshold values at which point the Error Flag goes Low. When the NCP5661 is above the nominal output voltage, the Error Flag will remain at logic High.

The external pullup resistor needs to be connected between  $V_{in}$  (Pin 1) and the Error Flag pin (Pin 5). A resistor of approximately  $100~k\Omega$  is recommended to minimize the current consumption. No pullup resistor is required if the Error Flag output is not being used.

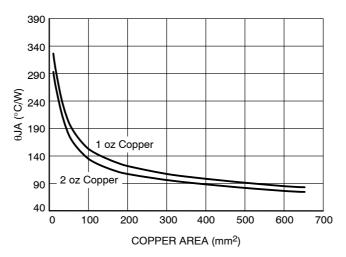


Figure 18. DFN6 Thermal Resistance vs. Copper Area

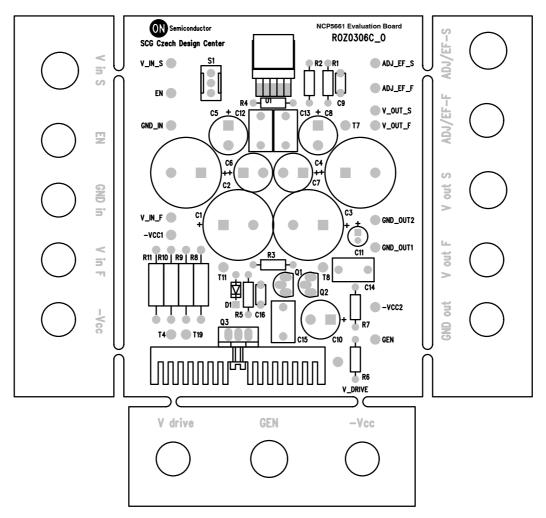


Figure 19. Test Board used for Evaluation

#### **ORDERING INFORMATION**

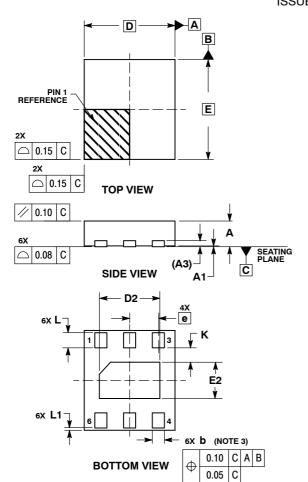
Device	Nominal Output Voltage	Package	Shipping†		
NCP5661DTADJRKG	Adj (Pb-Free)				
NCP5661DT12RKG	Fixed, 1.2 V (Pb-Free)				
NCP5661DT18RKG	Fixed, 1.8 V (Pb-Free)				
NCP5661DT25RKG	Fixed, 2.5 V (Pb-Free)				
NCP5661DT33RKG	Fixed, 3.3 V (Pb-Free)	DPAK	2500/Tape & Reel		
NCV5661DTADJRKG*	Adj (Pb-Free)				
NCV5661DT12RKG*	Fixed, 1.2 V (Pb-Free)				
NCV5661DT18RKG*	Fixed, 1.8 V (Pb-Free)	1			
NCV5661DT33RKG*	Fixed, 3.3 V (Pb-Free)				
NCP5661MNADJT2G	Adj (Pb-Free)				
NCP5661MN12T2G	Fixed, 1.2 V (Pb-Free)				
NCP5661MN15T2G	Fixed, 1.5 V (Pb-Free)				
NCP5661MN18T2G	Fixed, 1.8 V (Pb-Free)				
NCP5661MN25T2G	Fixed, 2.5 V (Pb-Free)				
NCP5661MN28T2G	Fixed, 2.8 V (Pb-Free)				
NCP5661MN30T2G	Fixed, 3.0 V (Pb-Free)	1			
NCP5661MN33T2G	Fixed, 3.3 V (Pb-Free)	DFN6			
NCV5661MNADJT2G*	Adj (Pb-Free)	3x3.3 mm	3000/Tape & Reel		
NCV5661MN12T2G*	Fixed, 1.2 V (Pb-Free)	1			
NCV5661MN15T2G*	Fixed, 1.5 V (Pb-Free)				
NCV5661MN18T2G*	Fixed, 1.8 V (Pb-Free)	1			
NCV5661MN25T2G*	Fixed, 2.5 V (Pb-Free)	1			
NCV5661MN28T2G*	Fixed, 2.8 V (Pb-Free)	1			
NCV5661MN30T2G*	Fixed, 3.0 V (Pb-Free)	1			
NCV5661MN33T2G*	Fixed, 3.3 V (Pb-Free)	1			

NOTE: Additional Fix output voltages are available upon request.

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
\*NCV rated devices are subjected to and meet the AECQ-100 quality standards.

#### PACKAGE DIMENSIONS

#### DFN6 3x3.3 MM, 0.95 PITCH CASE 506AX ISSUE O



- NOTES: 1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
- Y14.5M, 1994.

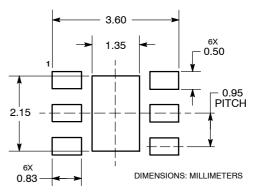
  2. CONTROLLING DIMENSION: MILLIMETERS.

  3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM TERMINAL.

  4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.80		0.90	
A1	0.00		0.05	
А3	0	.20 REF		
b	0.30		0.40	
D	3.00 BSC			
D2	1.90		2.10	
E	3.30 BSC			
E2	1.10		1.30	
е	0.95 BSC			
K	0.20			
L	0.40		0.60	
L1	0.00	0.15		

#### **SOLDERING FOOTPRINT\***

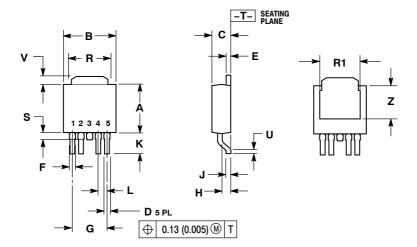


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

#### DPAK-5 CENTER LEAD CROP

CASE 175AA ISSUE A

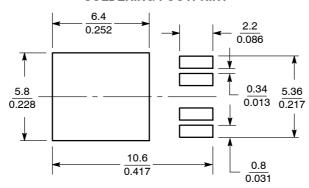


#### NOTES:

- 1. DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INC	ETEDE			
	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.235	0.245	5.97	6.22	
В	0.250	0.265	6.35	6.73	
O	0.086	0.094	2.19	2.38	
D	0.020	0.028	0.51	0.71	
Е	0.018	0.023	0.46	0.58	
F	0.024	0.032	0.61	0.81	
G	0.180	BSC	4.56 BSC		
Н	0.034	0.040	0.87	1.01	
7	0.018	0.023	0.46	0.58	
K	0.102	0.114	2.60	2.89	
L	0.045	BSC	1.14 BSC		
R	0.170	0.190	4.32	4.83	
R1	0.185	0.210	4.70	5.33	
S	0.025	0.040	0.63	1.01	
J	0.020		0.51		
٧	0.035	0.050	0.89	1.27	
Z	0.155	0.170	3.93	4.32	

#### **SOLDERING FOOTPRINT\***



SCALE 4:1 (mm/inches)

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